HALOGEN

Taiwan Semiconductor

10A, 45V Trench Schottky Rectifiers

FEATURES

• AEC-Q101 qualified

TAIWAN

- Patented Trench Schottky technology
- Low power loss, high efficiency

EMICONDUCTOR

- Ideal for automated placement
- Wettable flank
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter
- Automotive

MECHANICAL DATA

- Case: SMPC4.6U
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test

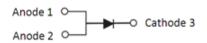
- Polarity: As marked
- Weight: 104mg (approximately)

KEY PARAMETERS						
PARAMETER VALUE UNIT						
I _F	10	А				
V _{RRM}	45	V				
I _{FSM}	220	А				
T _{J MAX}	175	°C				
Package	SMPC4.6U					

R_oHS



SMPC4.6U



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)						
PARAMETER		SYMBOL	TSUP10M45SH	UNIT		
Marking code on the device			10M45			
Repetitive peak reverse voltage		V _{RRM}	45	V		
Reverse voltage, total rms value		V _{R(RMS)}	32	V		
Forward current		I _F	10	А		
Surge peak forward current single	8.3 ms at T _A = 25°C		220	A		
half sine-wave superimposed on rated load	1.0 ms at T _A = 25°C	IFSM	330	A		
Junction temperature		TJ	-55 to +175	°C		
Storage temperature		T _{STG}	-55 to +175	°C		



THERMAL PERFORMANCE					
PARAMETER	SYMBOL	ТҮР	UNIT		
Junction-to-lead thermal resistance	R _{ƏJL}	6	°C/W		
Junction-to-ambient thermal resistance	R _{ƏJA}	45	°C/W		
Junction-to-case thermal resistance	R _{eJC}	9	°C/W		

Thermal Performance Note: Units mounted on PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 5.0A, T_J = 25^{\circ}C$	VF	0.50	-	V
	$I_F = 10.0A, T_J = 25^{\circ}C$		0.54	0.60	V
	$I_F = 5.0A, T_J = 125^{\circ}C$		0.39	-	V
	$I_F = 10.0A, T_J = 125^{\circ}C$		0.46	0.54	V
Reverse current @ rated V _R ⁽²⁾	$T_J = 25^{\circ}C$		-	200	μA
Reverse current @ rated v _R	T _J = 125°C	I _R	-	9	mA
Junction capacitance	1 MHz, V _R =4.0V	CJ	1099	-	pF

Notes:

1. Pulse test with PW=0.3 ms

2. Pulse test with PW=30 ms

ORDERING INFORMATION				
ORDERING CODE	PACKAGE	PACKING		
TSUP10M45SH S1G	SMPC4.6U	1,500/7" Plastic reel		
TSUP10M45SH S2G	SMPC4.6U	6,000/13" Plastic reel		



100

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

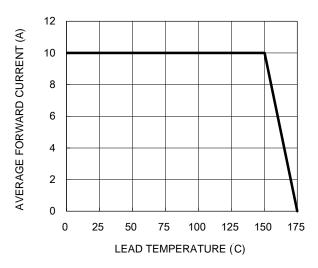
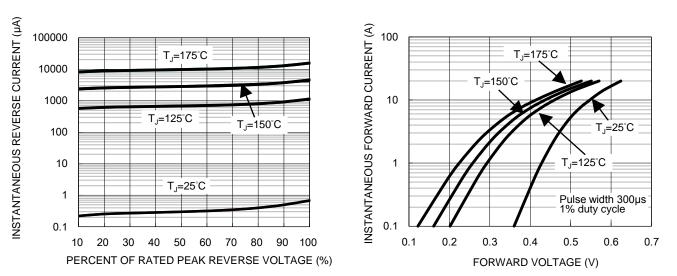


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics



10000

1000

100

1

f=1.0MHz Vsig=50mVp-p

CAPACITANCE (pF)

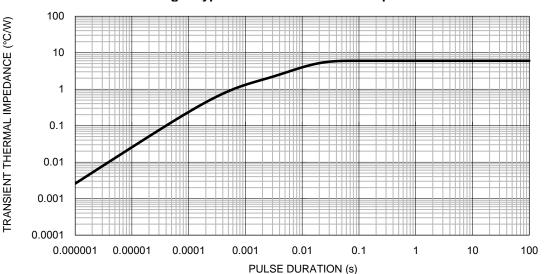


Fig.5 Typical Transient Thermal Impedance

Fig.2 Typical Junction Capacitance

10

REVERSE VOLTAGE (V)

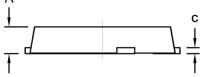
Fig.4 Typical Forward Characteristics

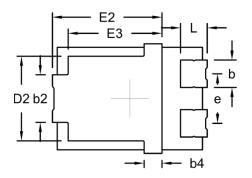


SMPC4.6U

TAIWAN SEMICONDUCTOR

95





SUGGESTED PAD LAYOUT

В

D

F

1

С

1

DIM.	Unit	(mm)	Unit ((inch)
	Min.	Max.	Min.	Max.
А	1.00	1.20	0.039	0.047
b	1.05	1.35	0.041	0.053
b2	1.90	2.20	0.075	0.087
b4	0.75 (NOM.)	0.030	(NOM.)
с	0.15	0.40	0.006	0.016
D	4.45	4.75	0.175	0.187
D1	4.25	4.35	0.167	0.171
D2	3.40	3.70	0.134	0.146
E	6.35	6.65	0.250	0.262
E1	6.05	6.15	0.238	0.242
E2	4.40	4.80	0.173	0.189
E3	3.94 (NOM.)		0.155 (NOM.)	
е	2.08 (NOM.)	0.082 (NOM.	
L	0.94	1.24	0.037	0.049
L1	0.05	0.35	0.002	0.014
М	0.65	1.15	0.026	0.045
Ν	0.25	0.75	0.010	0.030

Package body size D1 and E1 do not include mold flash Mold flash shall not exceed 0.1mm per side

Symbol	Unit (mm)	Unit (inch)
A	4.95	0.195
В	4.95	0.195
С	1.60	0.063
D	1.42	0.056
E	6.95	0.274
F	1.04	0.041

MARKING DIAGRAM

А

1



- E

P/N	= Marking Code
YW	= Date Code
F	= Factory Code

Linit (in ala)	



Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.